

### N-Channel 30-V (D-S) MOSFET

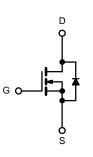
PRODUCT SUMMARY					
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)		
30	0.004 at V <sub>GS</sub> = 10 V	18	6.8 nC		
30	0.005 at V <sub>GS</sub> = 4.5 V	16	0.0110		

#### FEATURES

- Halogen-free
- TrenchFET<sup>®</sup> Power MOSFET
- Optimized for High-Side Synchronous Rectifier Operation
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested

#### **APPLICATIONS**

Notebook CPU Core
High-Side Switch



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T <sub>A</sub> = 25 °C, unless otherwise noted					
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	30	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20	v	
	T <sub>C</sub> = 25 °C		18		
Continuous Drain Current (T <sub>1</sub> = 150 °C)	T <sub>C</sub> = 70 °C	I <sub>D</sub>	16		
$Continuous Drain Current (1) = 150^{\circ} C)$	T <sub>A</sub> = 25 °C		15 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		13 <sup>b, c</sup>		
Pulsed Drain Current		I <sub>DM</sub>	50	— A	
Continuous Course Durin Diada Current	T <sub>C</sub> = 25 °C	1	3.8		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	۱ <sub>S</sub>	2.1 <sup>b, c</sup>		
Single Pulse Avalanche Current		I <sub>AS</sub>	22		
valanche Energy L = 0.1 mH		E <sub>AS</sub>	24	mJ	
	T <sub>C</sub> = 25 °C	- - P <sub>D</sub>	4.5		
Movimum Dowor Discinction	T <sub>C</sub> = 70 °C		2.8	w	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	۲D	2.5 <sup>b, c</sup>	v	
	T <sub>A</sub> = 70 °C		1.6 <sup>b, c</sup>	1	
Operating Junction and Storage Temperature Rang	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		

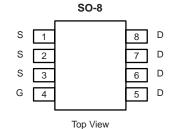
THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	R <sub>thJA</sub>	38	50	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	22	28	0/10	

Notes:

a. Base on T<sub>C</sub> = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s. d. Maximum under Steady State conditions is 85  $^{\circ}\text{C/W}.$ 



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<b>SPECIFICATIONS</b> $T_J = 25 \ ^{\circ}C$	1	erwise noted				
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static				-		-
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	30			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA		28		mV/°C
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	-		- 6		
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.0		3.0	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zero Gate Voltage Drain Current	lace	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA
Zero Gale voltage Drain Current	IDSS	$V_{DS} = 30$ V, $V_{GS} = 0$ V, $T_{J} = 55$ °C			10	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	20			Α
	Р	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 11 A		0.004		0
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 10 A		0.005		Ω
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 11 A		52		S
Dynamic <sup>b</sup>						
Input Capacitance	C <sub>iss</sub>			820		pF
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		195		
Reverse Transfer Capacitance	C <sub>rss</sub>			73		
Total Gate Charge	Qg	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 11 A		15	23	- nC
				6.8	10.2	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ = 15 V, $V_{GS}$ = 5 V, $I_{D}$ = 11 A		2.5		
Gate-Drain Charge	Q <sub>gd</sub>			2.3		
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.36	1.8	3.6	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			16	24	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, R <sub>1</sub> = 1.4 $\Omega$		12	18	1
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 9 \text{ A}, \text{ V}_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		16	24	
Fall Time	t <sub>f</sub>			10	20	
Turn-On Delay Time	t <sub>d(on)</sub>			8	16	ns
Rise Time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, \text{ R}_{1} = 1.4 \Omega$		10	20	-
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 9 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_g = 1 \Omega$		16	24	
Fall Time	t <sub>f</sub>			8	15	
Drain-Source Body Diode Characterist					1	
Continuous Source-Drain Diode Current	ا <sub>S</sub>	T <sub>C</sub> = 25 °C			25	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				50	A
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 9 A		0.8	1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	-		15	30	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			6	12	nC
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 9 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 \text{ °C}$		8		-
Reverse Recovery Rise Time	t <sub>b</sub>			7	1	ns

Notes:

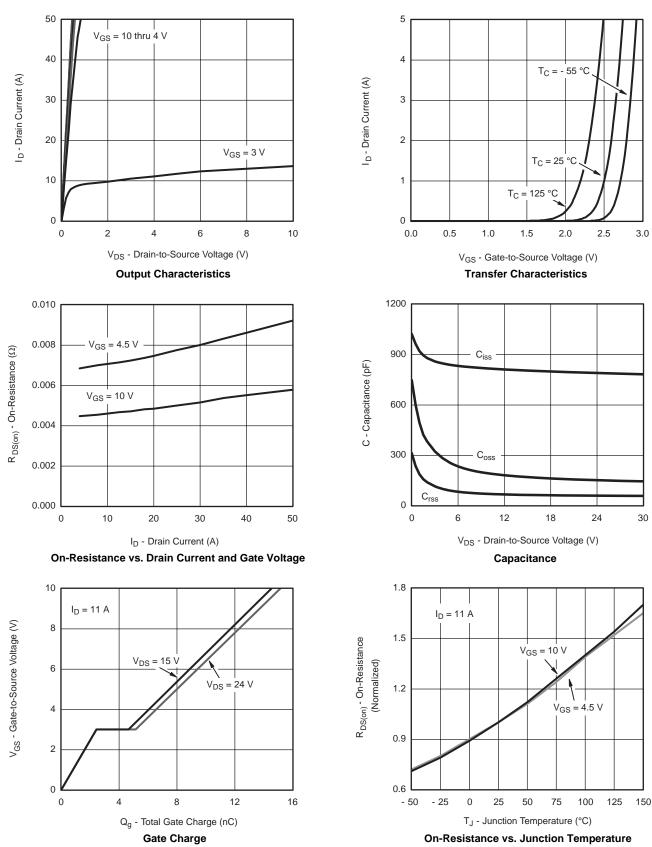
a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



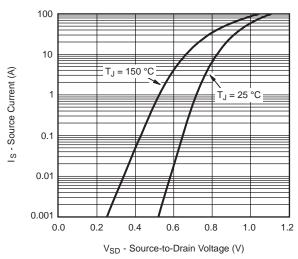
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



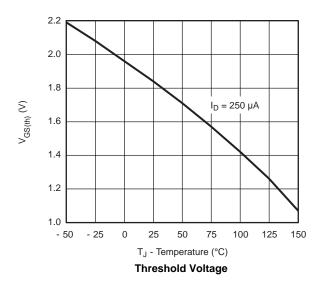
服务热线:400-655-8788

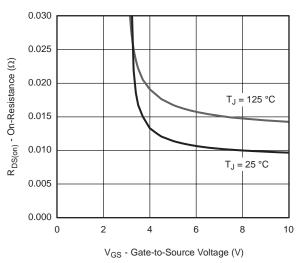


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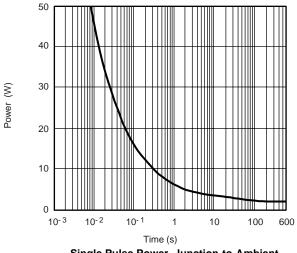




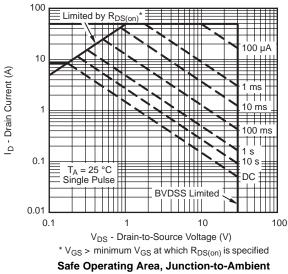




On-Resistance vs. Gate-to-Source Voltage

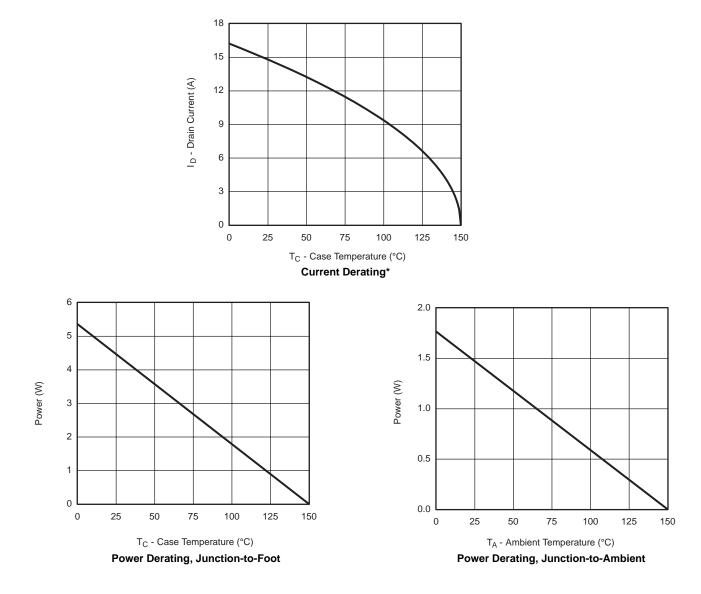






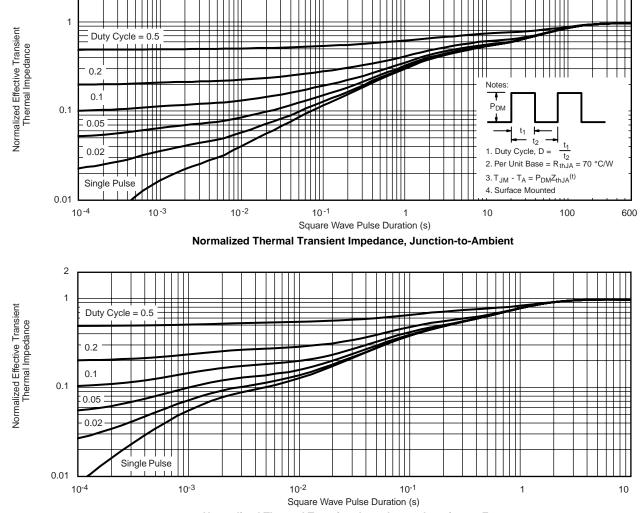


#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

Normalized Thermal Transient Impedance, Junction-to-Foot

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#### SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012





	MILLIMETERS		INCHES		
DIM	Min	Max	Min	Max	
A	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					



**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)



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